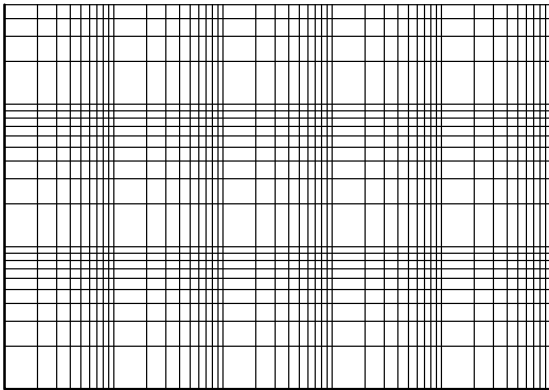
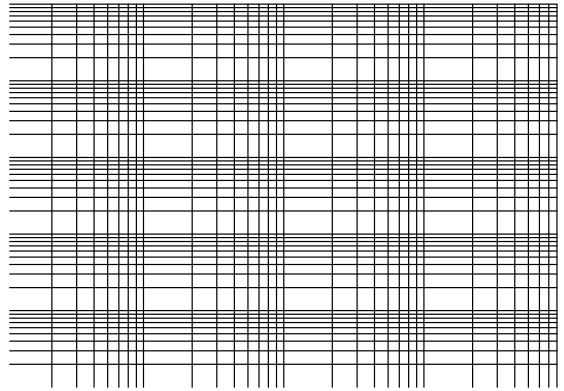
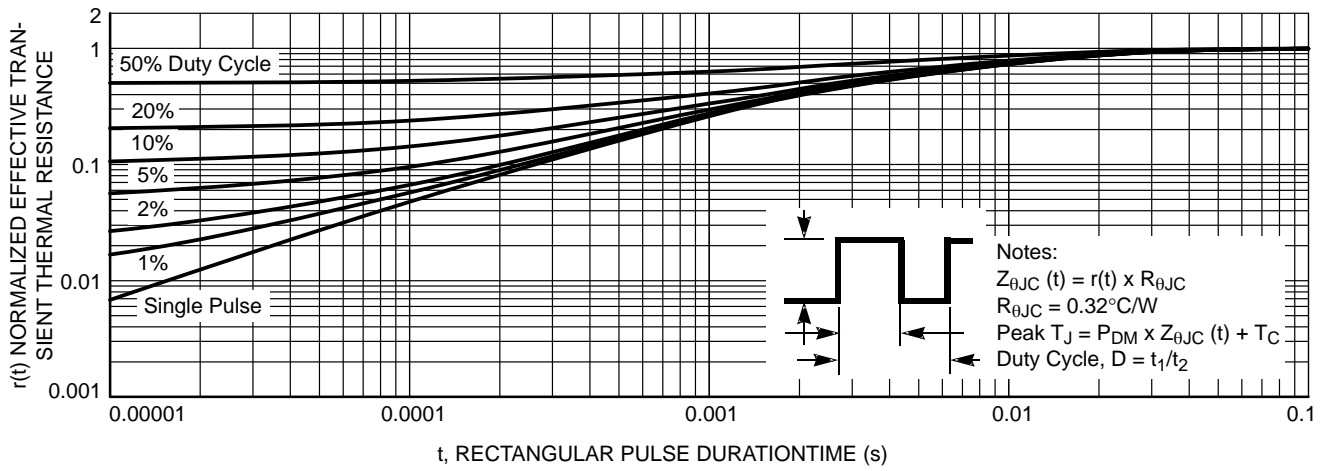


(continued)



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D²PAK7 (TO-263-7L HV)
CASE 418BJ
ISSUE B

DATE 16 AUG 2019

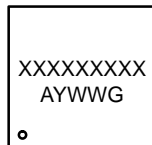
A

c2

H

C

**GENERIC
MARKING DIAGRAM***



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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